2SK3158

Silicon N Channel MOS FET High Speed Power Switching

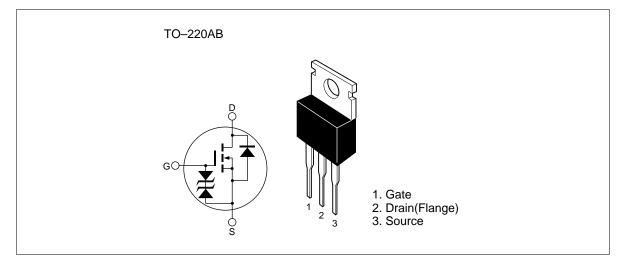
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ADE-208-757A(Z) Target Specification 2nd. Edition December 1998

Features

- Low on-resistance $R_{DS} = 35m\Omega$ typ.
- High speed switching
- 4V gate drive device can be driven from 5V source

Outline





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Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	150	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	30	A
Drain peak current	Note1 D(pulse)	120	А
Body-drain diode reverse drain current	I _{DR}	30	A
Avalanche current	I AP Note3	30	A
Avalanche energy	E _{AR} ^{Note3}	67	mJ
Channel dissipation	Pch Note2	100	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

Note: 1. $PW \le 10\mu s$, duty cycle $\le 1 \%$

2. Value at Tc = $25^{\circ}C$

3. Value at Tch = 25° C, Rg $\geq 50\Omega$

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	150	_	_	V	$I_{\rm D} = 10 {\rm mA}, V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_		V	$I_{g} = \pm 100 \mu A, V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16V, V_{DS} = 0$
Zero gate voltege drain current	I _{DSS}	_	_	10	μΑ	$V_{\rm DS} = 150 \ V, \ V_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	1.0	_	2.5	V	$I_{\rm D} = 1$ mA, $V_{\rm DS} = 10$ V
Static drain to source on state	$R_{\text{DS(on)}}$	_	35	45	mΩ	$I_{\rm D} = 15A, V_{\rm GS} = 10V^{\rm Note4}$
resistance	R _{DS(on)}		42	75	mΩ	$I_{\rm D} = 15A, V_{\rm GS} = 4V^{\rm Note4}$
Forward transfer admittance	y _{fs}	18	30	_	S	$I_{\rm D} = 15A, V_{\rm DS} = 10V^{\rm Note4}$
Input capacitance	Ciss	_	2600	_	pF	V _{DS} = 10V
Output capacitance	Coss		820	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	350	_	pF	f = 1MHz
Turn-on delay time	t _{d(on)}	_	25	_	ns	$I_{\rm D} = 15$ A, $V_{\rm GS} = 10$ V
Rise time	t,	_	180	_	ns	$R_{L} = 2\Omega$
Turn-off delay time	t _{d(off)}		600	_	ns	
Fall time	t _r	—	280	_	ns	
Body-drain diode forward voltage	V _{DF}		0.95	_	V	$I_{F} = 30A, V_{GS} = 0$
Body–drain diode reverse recovery time	t _{rr}	—	110	—	ns	$I_{F} = 30A, V_{GS} = 0$ diF/ dt =50A/µs
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Note: 4. Pulse test

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Unit: mm

Package Dimensions

10.16±0.2 2.79 ±0.2 f 3.6 + 0.1 - 0.08 9.5 4.44±0.2 8.0 1.26±0.15 1.27 $6.4 \stackrel{+ 0.2}{- 0.1}$ 15.0 ±0.3 18.5 ±0.5 1.2±0.1 1.27±0.1 1.5 max 14.0 ±0.5 0.5±0.1 7.8±0.5 0.76 ±0.1 Hitachi Code TO-220AB 2.54 ±0.5 2.7 max 2.54 ±0.5 EIAJ SC-46 JEDEC ____

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